# A wide variety of products including dust-proof type

6.2 × 6.3mm (Surface Mount Type)







# Typical Specifications

Items	Specifications
Rating (max.)	50mA 12V DC
Rating (min.)	10 µA 1V DC
Initial contact resistance	100mΩ max.
Travel (mm)	0.25

# ■ Product Line

# Top push type

Product No.	Operating force	Operating direction	Operating life (5mA 5V DC)	Stem color	Stem height	Minimum ord Japan	er unit (pcs.) Export	Drawing No.
SKHUAKE010	0.98N		300,000 cycles -	Green	2.5mm	3,000	3,000	1
SKHUALE010	1.57N	Top push		Black				
SKHUAME010	2.55N		100,000 cycles	Red				

# With ground terminal type

Product No.	Operating force	Operating	Operating Operating life Stem color		Stem height	Minimum ord	Drawing	
T TOUGET NO.	Operating force	direction	(5mA 5V DC)	Otern color	Otem neight	Japan	Export	No.
SKHUPKE010	0.98N		300,000 cycles -	Green		3,000	3,000	2
SKHUPLE010	1.57N	Top push		Black	2.5mm			
SKHUPME010	2.55N		100,000 cycles	Red				

# Dust-proof type

Product No.	Operating force		Operating life (5mA 5V DC)	Stem color	Stem height	Minimum ord	Drawing	
	Operating force					Japan	Export	No
SKHUBHE010	1.57N	Top push	50,000 cycles	Brown	3.1mm	3,000	3,000	3

# Dust-proof and with ground terminal type

Product No.	Operating force	Operating	Operating life (5mA 5V DC)	Stem color	Stem height	Minimum ord	Drawing	
Product No.	Operating force	direction				Japan	Export	No
SKHUQHE010	1.57N	Top push	F0.000 avala	Brown	2.1mm	3,000	3,000	4
SKHUQGE010	2.55N	TOP PUSIT	50,000 cycles	Red	3.1mm			

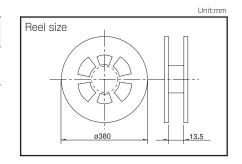
# Packing Specifications

# Taping

Num	ber of packages (	Tape width	Export package	
1 reel	1 case / Japan 1 case / export packing		(mm)	measurements (mm)
3,000	30,000 30,000		12	401×401×214

#### Note

For reels of 330mm diameter, please inquire.







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Dimensions

Unit:mm

No.	Photo	Style	PC board land dimensions (Viewed from switch mounting face)
1	Top push type	7.2 6.2 0.2 0.3 0.4 0.5 0.5 0.5 0.5 0.5 0.5 0.5 0.5 0.5 0.5	2/ c/ 4 9.5
2	With ground terminal type	7.2 6.2 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0	9.5  4 Ground terminal land
3	Dust-proof type	7.2 6.2 0.2 0.2 0.2 0.2 0.2 0.2 0.2 0.2 0.2 0	0.5 0.5 0.5
4	Dust-proof and with ground terminal type	7.2 6.2 0.2 0.2 0.2 0.2 0.2 0.2 0.2 0.2 0.2 0	9.5 4 T. Ground terminal land

# Circuit Diagram

Top push type	With ground terminal type
①—————————————————————————————————————	①

	Туре					arp Feeling T				
	Series	SKHU	SKTD	SKSN	SKTG	Surface Moui	SKSC	SKRT	SKRV	SKRH
		on the contract of the contrac	SIATE OF THE PROPERTY OF THE P	onton	NEW	6N62	SHOO!	on the state of th	- Control	
	Photo	The second second				0,2	Total Control			
	Features	_	Low-profile	Mid-mount	Half-n	nount	Low-profile	-		on switch switch
	Water-proof	0	•	_	•	_	_	_	_	_
	Dust-proof	0	•	_	•	_	_	_	_	_
	IP standard	_	67 equivalency	_	67 equivalency	-	_	-	_	_
Operatir	Top push	•	_	_		_	_	_	•	•
directio	Side push	_	•	•	•	•	•	•	•	•
	W	6.2	3.9	6.2	5.2	4.5	3.5	4.5	6.45	7.35
Dimensio (mm)		6.3	2.9	3	3.5	2.6	3.55	3.4	6.4	7.5
(11111)	Н	2.5/3.1	1.55	3.5	1.55	2.2	1.25	3.3	4	5
Operation force coverage	2N to 3N	Ţ	<b>\$</b>	<b>‡</b>	<b>\$</b>	1	1	<b>\$</b>		rant pages for duct description
	Travel (mm)	0.25	0.15	0.2	0.	15	0.	2		ant pages for duct description
G	round terminal	•	•	•	•	•	0	•	•	•
Operatin	ng temperature range	-40°C to +85°C	-30℃ to +85℃	-40℃ to +85℃	-;	30℃ to +85	5°C	-40°C to +90°C	-20℃ to +70℃	-40°C to +85°C
А	utomotive use	0	_	_	_	_	_	_	_	_
	Life Cycle	*3	<b>X</b> 2	<b>*</b> 2	<b>X</b> 2	<b>X</b> 2	<b>*</b> 2	<b>*</b> 2	<b>*</b> 2	<b>*</b> 2
	Rating (max.) (Resistive load)				5	OmA 12V E	)C			
Electrical	Rating (min.) (Resistive load)					10μΑ 1V D0	0			
performance	Insulation resistance				100ΜΩ	min. 100V [	OC 1min.			
	Voltage proof	250V AC 1min.	100V AC 1min.	250V A	AC 1min.	100V A	AC 1min.	250V AC 1min.	100V A	.C 1min.
Durability	Vibration		10	to 55 to 101 in the 3	Hz/min., the a direction of X	amplitude is (, Y and Z fo	1.5mm for all t r 2 hours resp	the frequenci sectively	es,	
Darability	Lifetime			Shall b	e in accordar	nce with indi	vidual specific	ations.		
	Cold		1	ı	-40℃ 96h				-30°C 96h	-40℃ 96h
Environmental performance	Dry heat	90℃ 96h	85℃ 96h	90℃ 96h	85℃ 96h		90℃ 96h		80℃ 96h	90℃ 96h
	Damp heat				60°C,	90 to 95%F	RH 96h			
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W : Width. The most outer dimension excluding terminal portion. D : Depth. The most outer dimension excluding terminal portion.

H: Height. The minimum dimension if there are variances.

#### Notes

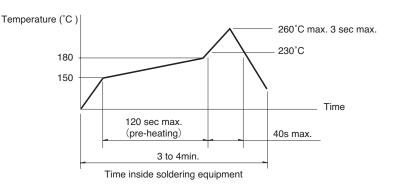
- 1. The automotive operating temperature range to be individually discussed upon request.
- 2. lacktriangle Indicates applicability to all products in the series, while  $\bigcirc$  indicates applicability to some products in the series.

# TACT Switch™ Soldering Conditions

### Condition for Reflow

Available for Surface Mount Type.

- 1. Temperature measurement: Thermocouple  $\phi$  0.1 to 0.2 CA (K) or CC (T) at solder joints (copper foil surface).
  - A heat resistive tape should be used to fix thermocouple.
- 2. Temperature profile



### Notes

- The above temperature shall be measured of the top of switch. There are cases where the PC board's temperature greatly differs from that of the switch, depending on the material, size, thickness of PC boards and others.
   The above-stated conditions shall also apply to switch surface temperatures.
- Soldering conditions differ depending on reflow soldering machines. Prior verification of soldering condition is highly recommended.

### Conditions for Auto-dip

Available for Snap-in Type and Radial Type.

	3.
Items	Condition
Flux built-up	Mounting surface should not be exposed to flux
Preheating temperature	Ambient temperature of the soldered surface of PC board. 100°C max.
Preheating time	60s max.
Soldering temperature	260°C max.
Duration of immersion	5s max.
Number of soldering	2times max.

### SKHH, SKPD Series

Items	Condition
Flux built-up	Mounting surface should not be exposed to flux
Preheating temperature	Ambient temperature of the soldered surface of PC board. 110°C max.
Preheating time	60s max.
Soldering temperature	260°C max.
Duration of immersion	5s max.
Number of soldering	2times max.

### SKQJ, SKQK, SKEG Series

Items	Condition
Flux built-up	Mounting surface should not be exposed to flux
Preheating temperature	Ambient temperature of the soldered surface of PC board. 100°C max.
Preheating time	45s max.
Soldering temperature	255℃ max.
Duration of immersion	5s max.
Number of soldering	2times max.

# Manual Soldering

Items	Condition
Soldering temperature	350℃ max.
Duration of soldering	3s max.
Capacity of soldering iron	60W max.

### SKHH, SKHW, SKRG, SKPD Series

Items	Condition
Soldering temperature	360°C max.
Duration of soldering	3s max.
Capacity of soldering iron	60W max.

### SKTD, SKTG, SKQJ, SKQK, SKEG Series

Items	Condition
Soldering temperature	350°C max.
Duration of soldering	3s max.
Capacity of soldering iron	20W max.

### Notes

- 1. Prevent flux penetration from the top side of the TACT Switch™.
- 2. Switch terminals and a PC board should not be coated with flux prior to soldering.
- 3. The second soldering should be done after the switch is stable with normal temperature.
- 4. Use the flux with a specific gravity of min 0.81. (EC-19S-8 by TAMURA Corporation, or equivalents.)

